#### STW57N65M5-4



# N-channel 650 V, 0.056 Ω typ., 42 A, MDmesh™ V Power MOSFET in a TO247-4 package

Datasheet - production data

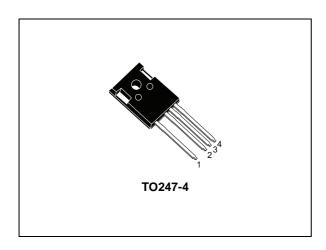
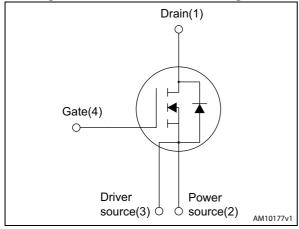


Figure 1. Internal schematic diagram



#### **Features**

Order code	V <sub>DS</sub> @ T <sub>Jmax</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STW57N65M5-4	710 V	$0.063~\Omega$	42 A

- Higher V<sub>DS</sub> rating
- Higher dv/dt capability
- Excellent switching performance thanks to the extra driving source pin
- Easy to drive
- 100% avalanche tested

#### **Applications**

- High efficiency switching applications:
  - Servers
  - PV inverters
  - Telecom infrastructure
  - Multi kW battery chargers

#### **Description**

This device is an N-channel MDmesh™ V Power MOSFET based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESH™ horizontal layout structure. The resulting product has extremely low onresistance, which is unmatched among siliconbased Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

**Table 1. Device summary** 

Order code	Marking	Package	Packaging
STW57N65M5-4	57N65M5	TO247-4	Tube

Contents STW57N65M5-4

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STW57N65M5-4 Electrical ratings

## 1 Electrical ratings

**Table 2. Absolute maximum ratings** 

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate- source voltage	±25	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	42	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	26.5	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	168	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	250	W
I <sub>AR</sub>	Max current during repetitive or single pulse avalanche (pulse width limited by T <sub>JMAX</sub> )	11	А
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)	960	mJ
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	50	V/ns
T <sub>stg</sub>	Storage temperature	- 55 to 150	°C
Tj	Max. operating junction temperature	150	°C

<sup>1.</sup> Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	0.50	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max	50	°C/W

<sup>2.</sup>  $I_{SD} \le 42$  A, di/dt = 400 A/ $\mu$ s, peak  $V_{DS} < V_{(BR)DSS}$ ,  $V_{DD} = 400$  V

<sup>3.</sup>  $V_{DS} \le 520 \text{ V}$ 

Electrical characteristics STW57N65M5-4

### 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0	650			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 650 V V <sub>DS</sub> = 650 V, T <sub>C</sub> =125 °C			1 100	μA μA
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 25 V			± 100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_D = 21 \text{ A}$		0.056	0.063	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	4200	-	pF
C <sub>oss</sub>	Output capacitance	$V_{DS} = 100 \text{ V, f} = 1 \text{ MHz,}$	-	115	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0$	-	9	-	pF
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	$V_{GS} = 0$ , $V_{DS} = 0$ to 520 V	-	303	-	pF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	$V_{GS} = 0$ , $V_{DS} = 0$ to 520 V	-	93	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	1.3	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 520 V, I <sub>D</sub> = 21 A,	-	98	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V	-	23	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 16)	-	40	-	nC

C<sub>o(tr)</sub> is a constant capacitance value that gives the same charging time as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 to 80% V<sub>DSS</sub>.

4/14

<sup>2.</sup>  $C_{o(er)}$  is a constant capacitance value that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(V)</sub>	Voltage delay time	V <sub>DD</sub> = 400 V, I <sub>D</sub> = 28 A,	-	79	-	ns
t <sub>r(V)</sub>	Voltage rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$	-	9	-	ns
t <sub>f(i)</sub>	Current fall time	(see Figure 15)	-	8	-	ns
t <sub>c(off)</sub>	Crossing time	(see <i>Figure 20</i> )	-	14	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		42	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		168	Α
V <sub>SD</sub> (2)	Forward on voltage	I <sub>SD</sub> = 42 A, V <sub>GS</sub> = 0	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 42 A,	-	418		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 100 A/μs	-	8		μC
I <sub>RRM</sub>	Reverse recovery current	V <sub>DD</sub> = 100 V (see <i>Figure 17</i> )	-	40		Α
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 42 A,	-	528		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 100 A/μs   V <sub>DD</sub> = 100 V, T <sub>i</sub> = 150 °C	-	12		μC
I <sub>RRM</sub>	Reverse recovery current	(see <i>Figure 17</i> )	-	44		Α

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: pulse duration =  $300 \mu s$ , duty cycle 1.5%

Electrical characteristics STW57N65M5-4

#### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

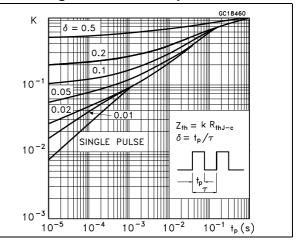


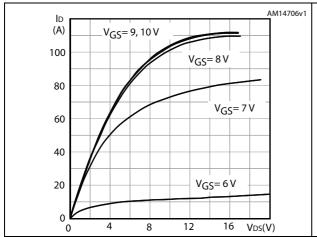
Figure 4. Output characteristics

Single pulse

100

V<sub>DS</sub>(V)

Figure 5. Transfer characteristics



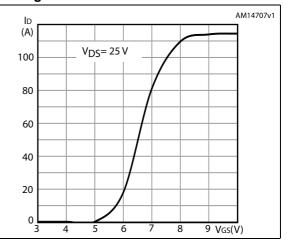
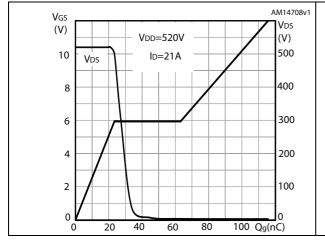


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance



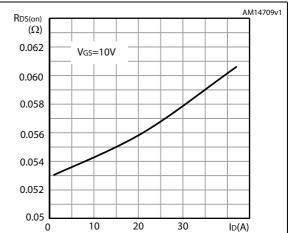


Figure 8. Capacitance variations

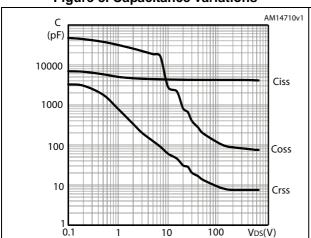


Figure 9. Output capacitance stored energy

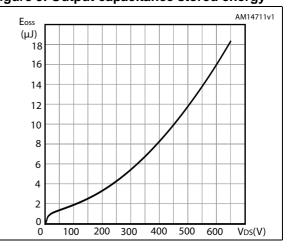
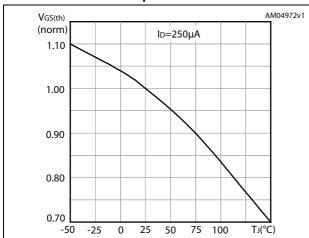


Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on-resistance vs temperature



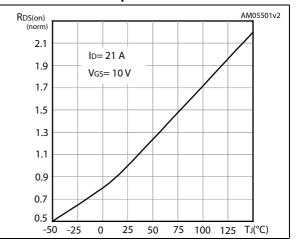
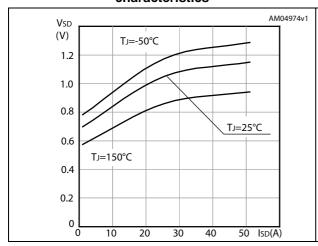
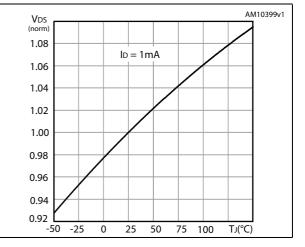


Figure 12. Source-drain diode forward characteristics

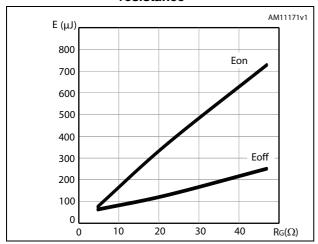
Figure 13. Normalized  $V_{DS}$  vs temperature





Electrical characteristics STW57N65M5-4

Figure 14. Switching losses vs gate resistance <sup>(1)</sup>



1. Eon including reverse recovery of a SiC diode.

STW57N65M5-4 Test circuits

### 3 Test circuits

Figure 15. Switching times test circuit for resistive load

Figure 16. Gate charge test circuit

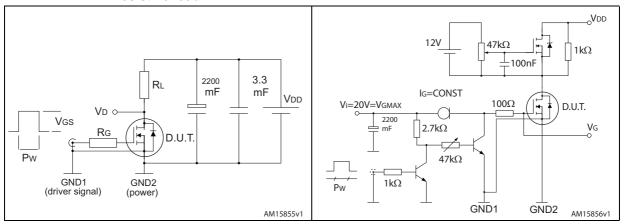


Figure 17. Test circuit for inductive load switching and diode recovery times

Figure 18. Unclamped inductive load test circuit

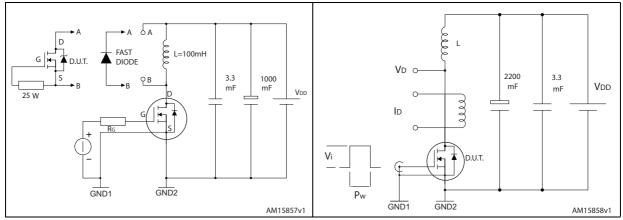
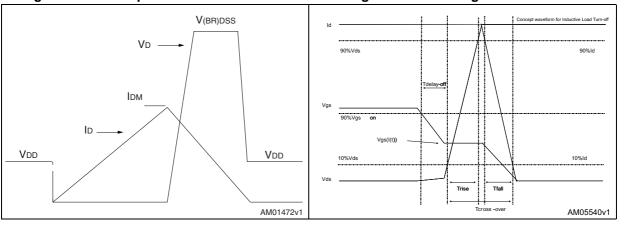


Figure 19. Unclamped inductive waveform

Figure 20. Switching time waveform



# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 8. TO247-4 mechanical data

		mm.		
Dim.	Min.	Тур.	Max.	
А	A 4.90 5.00			
A1	2.31	2.41	2.51	
A2	1.90	2.00	2.10	
b	1.16		1.29	
b1	1.15	1.20	1.25	
b2	0		0.20	
С	0.59		0.66	
c1	0.58	0.60	0.62	
D	20.90	21.00	21.10	
D1	16.25	16.55	16.85	
D2	1.05	1.20	1.35	
D3	24.97	25.12	25.27	
Е	15.70 15.80 15		15.90	
E1	13.10	13.30	13.50	
E2	4.90	5.00	5.10	
E3	2.40	2.50	2.60	
е	2.44	2.54	2.64	
e1	4.98	5.08	5.18	
L	19.80	19.92	20.10	
Р	3.50	3.60	3.70	
P1			7.40	
P2	2.40	2.50	2.60	
Q	5.60		6.00	
S		6.15		
Т	9.80		10.20	
U	6.00		6.40	

øP1 Α2 [22  $\Box$ D3 øP2 A1 b2 b (x4) e (x2) SECTION A-A BASE METAL WITH PLATING 8405626\_A

Figure 21. TO247-4 drawing

STW57N65M5-4 Revision history

# 5 Revision history

Table 9. Document revision history

Date	Revision	Changes
17-Apr-2013	1	First release.
28-Jun-2013	2	<ul><li>Modified: Figure 1, 15, 16, 17, 18</li><li>Minor text changes</li></ul>

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